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**Fabrication Method:**

Molded

**Body Mounting Hole Accommodation Diameter:**

0.330 inches

**Mounting Hole Style:**

Round, flatted

**Specific Equipment Accommodated:**

Semiconductor device

**Contact Material:**

Copper alloy

**Contact Surface Treatment:**

Silver

**Accommodated Contact Quantity:**

4

**Polarization Type:**

Center key hole

**Distance From Flatted Portion To Opposite Surface:**

0.280 inches

**Mounting Type For Which Designed:**

Chassis

**Contact Position Arrangement Style:**

Rectangular

**Precious Material And Location:**

Contact surfaces silver

**Precious Material And Weight:**

0.020 silver grains, troy

**Precious Material:**

Silver

**Terminal Type And Quantity:**

4 printed circuit

**Shelf Life:**

N/a

**Unit Of Measure:**

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**Demilitarization:**

No

**Fiig:**

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